RD-ECR (Engineering Change Request)

申請人: 硬體課/譚德和 Kevin_Tan　　表單號: 116　申請日期: 2026-10-01

Proposed Change	☐ Design modification 設計修改 ☑ Second source change 替代料變更 ☐ Material change 材料變更 ☐ Manufacturer change 製造商變更 ☐ Process sequency change 工序變更 ☐ Factory change 工廠變更 ☐ Equipment/Tooling change 設備/模具變更 ☐ Process/Method/Condition change 加工流程/方法 /條件變更 ☐ Others 其他			EC No	EC26100401
-	N/A			Initiator	譚德和 Kevin_Tan(D0705)
Reason for Change	Due to the "EVER" connector shortage issue, add second source "XINYA".			Issue Date	2026-10-01
Model / Part No	Please refer to the attached file.			Requester Dept	DV11M009-生管課
Implementation Type	○ 1. Immediately Change 立即切換 ◉ 2. Running Change 自然切換 ○ 3. Other 其他			-	N/A
PM	王志維 Ryan_Wang(D0480)	Sales	陳冠華 Oliver_Chen(D0525)	File attached 附件上傳	3FM00X00210_Compariso... 3FM00X01420_Compariso... 3FM00X02520_Compariso... 3FM00X03510_Compariso... 3FM00608910_Compariso... 設計變更審查會議記錄-G版... 備忘錄樣式.pdf 試打紀錄.pdf 影響機種清單.pdf RGD2461AMI Connector E...
Customer Approval	○ Needed ◉ Not needed	Customer Name	N/A	Customer Sign-off Area 客戶簽核	
Invalid	◉ No ○ Yes	-	N/A		

Material Change Description 物料變更說明

No	Subassembly	T	PartNo	Description	Qty	Location	Stock	Remark
1	2AAD182R038	B						
1	2AAD182R038	A	3FM00202550	CONN.M (W2011-02SVA-B,TOP,2.0mm,XINYA)	1.000	CN16		1st: 3FM00202550 2nd: 3FM00202520
2	2AAD182R038	B						
2	2AAD182R038	A	3FM00302550	CONN.M (W2011-03SVA-B,TOP,2.0mm,XINYA)	1.000	CN7		1st: 3FM00302550 2nd: 3FM00302520
3	2AAD182R038	B						
3	2AAD182R038	A	3FM00400240	CONN.M (W2411-04SVA-M,TOP,2.5mm,XINYA)	1.000	CN1		1st: 3FM00400240 2nd:3FM00400210
4	2AAD182R038	B						
4	2AAD182R038	A	3FM00402550	CONN.M (W2011-04SVA-B,TOP,2.0mm,XINYA)	1.000	CN11		1st:3FM00402550 2nd:3FM00402520
5	2AAD182R038	B						
5	2AAD182R038	A	3FM00602550	CONN.M (W2011-06SVA-B,TOP,2.0mm,XINYA)	1.000	CN9		1st: 3FM00602550 2nd: 3FM00602520
6	2AAD182R038	B						
6	2AAD182R038	A	3FM00802550	CONN.M (W2011-08SVA-B,TOP,2.0mm,XINYA)	1.000	CN2		1st: 3FM00802550 2nd: 3FM00802520
7	2AAD182R038	B						
7	2AAD182R038	A	3FM00902550	CONN.M (W2011-09SVA-B,TOP,2.0mm,XINYA)	1.000	CN8		1st: 3FM00902550 2nd: 3FM00902520
8	2AAD363R03P	B						
8	2AAD363R03P	A	3FM00402550	CONN.M (W2011-04SVA-B,TOP,2.0mm,XINYA)	1.000	CN6		1st:3FM00402550 2nd:3FM00402520
9	2AAD363R03P	B						
9	2AAD363R03P	A	3FM00403530	CONN.M (M3962-4AC-A,TOP,3.96mm,XINYA)	1.000	CN3		1st: 3FM00403530 2nd: 3FM00403510
10	2AAD462R03U	B						
10	2AAD462R03U	A	3FM00402550	CONN.M (W2011-04SVA-B,TOP,2.0mm,XINYA)	1.000	J10		1st:3FM00402550 2nd:3FM00402520
11	2AAD462R03U	B						
11	2AAD462R03U	A	3FM00601440	CONN.M (W2011-06RVA-S,SIDE,2.0mm,XINYA)	1.000	P4		1st: 3FM00601440 2nd: 3FM00601420
12	2AAD462R03U	B						
12	2AAD462R03U	A	3FM00608920	CONN.M (S1311-06SWA-S02-R,1.25mm,XINYA)	1.000	P3		1st: 3FM00608920 2nd: 3FM00608910
13	2AAD599R538	B						
13	2AAD599R538	A	3FM00302550	CONN.M (W2011-03SVA-B,TOP,2.0mm,XINYA)	2.000	CN1003,CN1004		1st: 3FM00302550 2nd: 3FM00302520
14	2AAD599R538	B						
14	2AAD599R538	A	3FM00502550	CONN.M (W2011-05SVA-B,TOP,2.0mm,XINYA)	1.000	CN702		1st: 3FM00502550 2nd: 3FM00502520
15	2AAD695R038	B						

No	Subassembly	T	PartNo	Description	Qty	Location	Stock	Remark
15	2AAD695R038	A	3FM00402550	CONN.M (W2011-04SVA-B,TOP,2.0mm,XINYA)	2.000	CN603,CN803		1st:3FM00402550 2nd:3FM00402520 3rd: 3FM00417010
16	2AAD695R038	B						
16	2AAD695R038	A	3FM00502550	CONN.M (W2011-05SVA-B,TOP,2.0mm,XINYA)	1.000	CN801		1st: 3FM00502550 2nd: 3FM00502520 3rd: 3FM00517010
17	2AADLB4R03R	B						
17	2AADLB4R03R	A	3FM00302550	CONN.M (W2011-03SVA-B,TOP,2.0mm,XINYA)	1.000	CN52		1st: 3FM00302550 2nd: 3FM00302520
18	2AADLGVR53E	B						
18	2AADLGVR53E	A	3FM00400240	CONN.M (W2411-04SVA-M,TOP,2.5mm,XINYA)	1.000	CN2		1st: 3FM00400240 2nd: 3FM00400210

Engineering Change Assessment Item List 工程變更評估項目清單

1. Application for Revision of Specification or Drawing(s) for delivery 是否有修改交貨的規格或圖面	1.Confirm	○ Yes ● No need	1.Remark	N/A
2. Standards or Regulatories impact 是否有評估適用之標準或主管機關之相關法規的申請	2.Confirm	○ Yes ● No need	2.Remark	無影響
3. Change point of PCB mounting PCBA插件位置是否變更	3.Confirm	○ Yes ● No need	3.Remark	N/A
4. PCBA Process Changes PCBA製程是否變更	4.Confirm	○ Yes (Continue checking below) ● No	4.Remark	無影響
_ 4-1) Change of Reflow temperature 迴焊溫度是否變更	4-1 Confirm	○ Yes ● No need	4-1.Remark	無影響
_ 4-2) Change of bonding temperature 膠合溫度是否變更	4-2 Confirm	○ Yes ● No need	4-2.Remark	無影響
_ 4-3) Change of Manual Soldering temperature 人工手焊工具之溫度是否變更	4-3 Confirm	○ Yes ● No need	4-3.Remark	無影響
_ 4-4) Change of storage condition after protection humidity package 防潮包裝完成後的儲存條件是否變更	4-4 Confirm	○ Yes ● No need	4-4.Remark	無影響
5. Reliability test report(Test result and data) 是否有可靠性測試報告(測試結果及數據)	5.Confirm	● Yes ○ No need	5.Remark	參考附件
6. Process FMEA(Medical only) 是否有進行製程失效模式與效應分析	6.Confirm	○ Yes ● No need	6.Remark	N/A
7. Design FMEA(Medical only) 是否有進行設計失效模式與交應分析	7.Confirm	○ Yes ● No need	7.Remark	N/A
8. Risk Management(Medical only) 是否有進行風險管理評估	8.Confirm	○ Yes ● No need	8.Remark	N/A
9. Change points due to the modification 是否此修改會延伸導致其他變更點	9.Confirm	○ Yes ● No need	9.Remark	N/A
10. Initial Supply Control implements plan or result 是否有實施供料控制評估	10.Confirm	○ Yes ● No need	10.Remark	替代料 Running Change，系統備註
_ 10-1) Confirm the work order or order number or date for the implementation start of the engineering change 確認工程變更開始實施之工單或訂單號碼或日期	10-1 Confirm	○ Yes ● No need	10-1.Remark	替代料 Running Change，系統備註
_ 10-2) Coordinate the handling methods for related products and materials 協調相關產品及材料處理方法	10-2 Confirm	○ Yes ● No need	10-2.Remark	替代料 Running Change，系統備註

_ 10-3) Arrange th production schedule 處理生產日程之安排	10-3 Confirm	○ Yes ◉ No need	10-3.Remark	替代料 Running Change，系統備註
_ 10-4) Control the changed materials 變更材料之管制	10-4 Confrim	○ Yes ◉ No need	10-4.Remark	無需變更材料管制
_ 10-5) Establish relevant execution control records for EC materials, register traceability data for each material 建立有關工程變更物料之相關執行管控記錄、登錄各項物料追溯性資料	10-5 Confirm	○ Yes ◉ No need	10-5.Remark	替代料 Running Change，系統備註
11. Training Requirement 若此一變更影響製程或檢驗，是否需要再做人員訓練	11.Confrim	○ Yes ◉ No need	11.Remark	N/A
12-1. Modification contents(For example, the following documents) 是否有評估此變更之各項相關文件(如下)	12-1 Confirm	☐ QC control plan ☐ Service Manual ☐ Others ☑ Not needed	12-1.Remark	N/A
12-2. Modification contents(For example, the following documents) 是否有評估此變更之各項相關文件(如下)	12-2 Confirm	☐ SIP ☐ SOP ☐ Others ☑ No need	12-2.Remark	無影響
12-3. Modification contents(For example, the following documents) 是否有評估此變更之各項相關文件(如下)	12-3 Confirm	☑ MDF ☑ DMR ☐ Approval Sheet ☐ Engineering Spec ☐ Others ☑ Not needed	12-3.Remark	N/A
DIVA 鈺緯科技開發股份有限公司		版本：C		表單編號：QR-736-05

簽核列表 ◉ 表格 ○ 圖形

序號	簽核人	簽核結果	簽核意見
1	**盧俊宇 Jackylu** 二階主管(課/部級)	**同意** 2026-10-02 08:52	
2	**張鈞凱 Ericchang** ECR-DQE人員	**同意** 2026-10-02 13:31	無影響EMI
2	**林雪清 Joe_Lin** ECR-DQE人員	**同意** 2026-10-08 14:54	測試報告已上傳如附件，測試PASS
2	**林金封 Jim_Lin** ECR-DQE人員	**同意** 2026-10-08 16:29	N/A
2	**呂旻峰 Jack** ECR-DQE人員	**同意** 2026-10-12 17:12	N/A
3	**廖榮棋 Rongchi_Liao** DQE主管	**同意** 2026-10-12 17:28	
4	**劉証瑋 Dennis_Liu** [陳冠華 Oliver_Chen 加簽]Sales	**同意** 2026-10-13 11:01	
5	**胡靜文 Estela_Hu** [陳冠華 Oliver_Chen 加簽]Sales	**同意** 2026-10-14 11:16	
6	**王志維 Ryan_Wang** PM	**同意** 2026-10-14 15:37	
6	**陳冠華 Oliver_Chen** Sales	**同意** 2026-10-19 14:45	
7	**楊建勛 Michael_Young** R&D Director [通知]	**同意** 2026-10-19 14:45	[通知]
8	**蕭玉桃 Momohsiao** ECR-PIC人員	**同意** 2026-10-19 15:05	
9	**王世炫 Hsuan_Wang** ECR-PE人員	**同意** 2026-10-19 15:09	
10	**林益銓 Nick_Lin** PE	**同意** 2026-10-19 15:10	
11	**黃振哲 Terry_Huang** ECR-PMC人員	**同意** 2026-10-19 16:24	

序號	簽核人	簽核結果	簽核意見
12	**邱羽萱 Lily_Chiu** PMC	**同意** 2026-10-19 16:31	
13	**黃瓊玉 Joannehuang** ECR-PD人員	**同意** 2026-10-19 16:48	
13	**李慧珊 Sandra** ECR-SCM人員	**同意** 2026-10-19 17:26	
13	**郭修榮 Omega_Kuo** PD	**同意** 2026-10-20 10:27	
14	**廖映涵 Miu_Liao** [李慧珊 Sandra 加簽]	**同意** 2026-10-20 10:40	
15	**李金龍 Kevin_Lee** ECR-QA人員	**同意** 2026-10-20 10:59	
16	**陳泰盛 Tyson_Chen** QA	**同意** 2026-10-20 11:20	
17	**楊建勛 Michael_Young** R&D Director	**同意** 2026-10-20 11:27	
18	**蕭玉桃 Momohsiao** ECR-PIC人員	**同意** 2026-10-20 12:00	
19	**譚德和 Kevin_Tan** SAP核發	**同意** 2026-10-20 13:13	